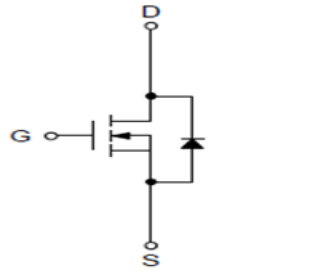
适用于 60V 电动车控制器

POWER MOSFET

Features

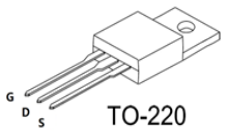
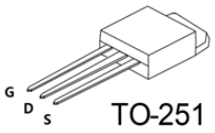
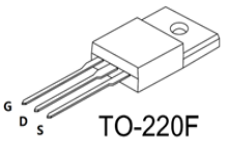
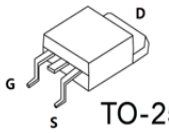
- 80V,80A N-Channel MOSFET
- $R_{DS(on)(typ.)}$=6.5mΩ @V_{GS}=10V
- High ruggedness
- Fast switching
- 100% avalanche tested
- Exceptional dv/dt capability



N-Channel MOSFET

Applications

- Switching application
- Motor drive

SF80N80P	 TO-220	SF80N80I	 TO-251
SF80N80F	 TO-220F	SF80N80D	 TO-252

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_{DSS}	Drain-Source Voltage	80	V
V_{GS}	Gate-Source Voltage	±25	V
I_D	Continuous Drain Current(TC=25℃)	80	A
	Continuous Drain Current(TC=100℃)	65	A
I_{DM}	Pulsed Drain Current(Note 1)	320	A
EAS	Single Pulsed Avalanche Energy(Note 2)	256	mJ
P_D	Maximum Power Dissipation (T_C=25 ℃)	150	W
	Maximum Power Dissipation (T_C=100℃)	75	W
T_J	Operating Junction Temperature Range	-55 to +185	℃
T_{STG}	Storage Temperature Range	-55 to +185	℃

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2.Starting T_J=25℃,L=1.0mH,R_G=25Ω,I_D=37A,V_{GS}=10V

Thermal data

Symbol	Parameter	Max.	Units
$R_{th\ J\text{-}C}$	Thermal Resistance, Junction to case	1	℃/ W

Electrical Characteristics (TC=25℃ unless otherwise noted)

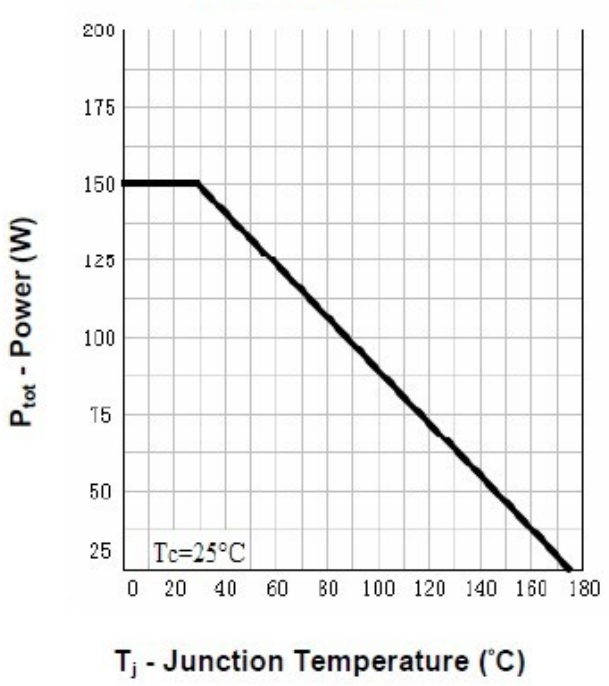
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250uA	80			V
I_{DSSS}	Drain-Source Leakage Current	V_{DS}=80V, V_{GS}=0V			1	uA
I_{GSS}	Gate Leakage Current, Forward	V_{GS}=25V, V_{DS}=0V			100	nA
	Gate Leakage Current, Reverse	V_{GS}= -25V, V_{DS}=0V			-100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS}, I_D=250uA	2	3	4	V
$R_{DS(on)}$	Collector-Emitter Saturation Voltage	V_{GS}=10V, I_D=40A		6.5	7.5	mΩ
gfs	Forward Transconductance	V_{DS}=15V, I_D=30A		28		S
Q_g	Total Gate Charge	V_{DD}=30V V_{GS}=10V I_D=40A		64	120	nC
Q_{gs}	Gate-Source Charge			13		nC
Q_{gd}	Gate-Drain Charge			22		nC
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=30V V_{GS}=10V I_D=40A R_G=7Ω	-	14	-	ns
t_r	Turn-on Rise Time		-	16	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	31	-	ns
t_f	Turn-off Fall Time		-	54	-	ns
C_{iss}	Input Capacitance	V_{DS}=30V V_{GS}=0V f = 1MHz	-	3400	-	pF
C_{oss}	Output Capacitance		-	450	-	pF
C_{rss}	Reverse Transfer Capacitance		-	170	-	pF
R_{Gint}	Integrated gate resistor			1.4		Ω

Source-Drain Ratings and Characteristics (TC=25℃ unless otherwise noted)

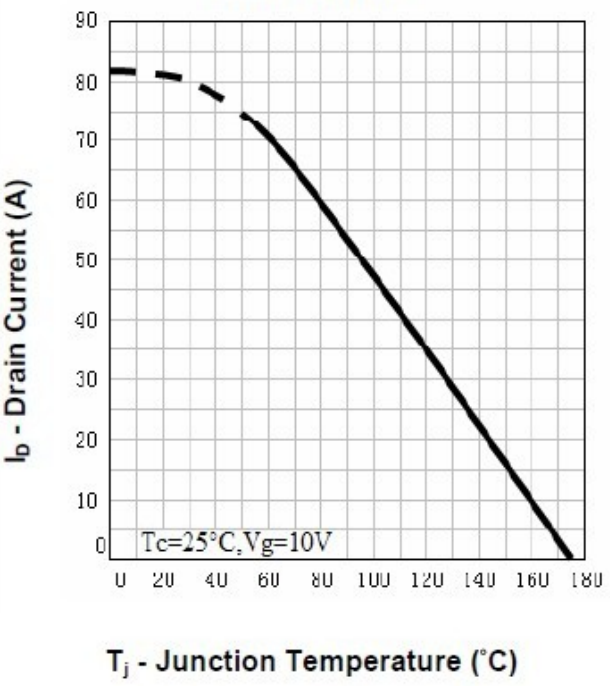
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage	V_{GS}=0V,I_S=40A	-	0.82	1.3	V
I_S	Continuous Diode Forward Current				80	A
t_{rr}	Reverse Recovery Time	V_{DD}=25V,I_S=40A dI_F/dt=100A/us	-	48		ns
Q_{rr}	Reverse Recovery Charge		-	105		nC

Typical Characteristics

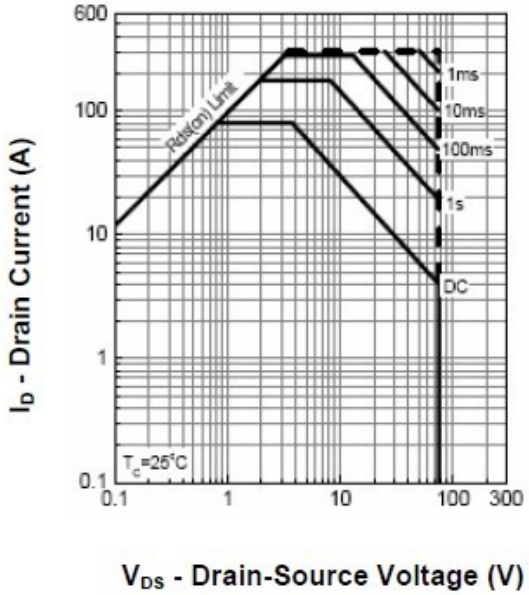
Power Dissipation



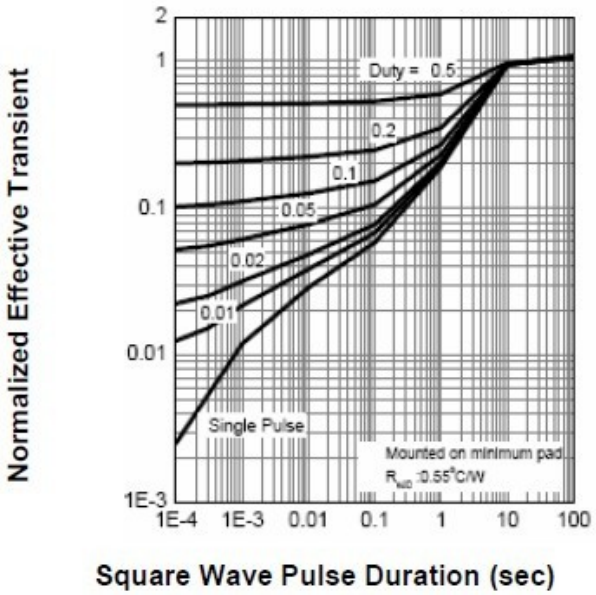
Drain Current



Safe Operation Area

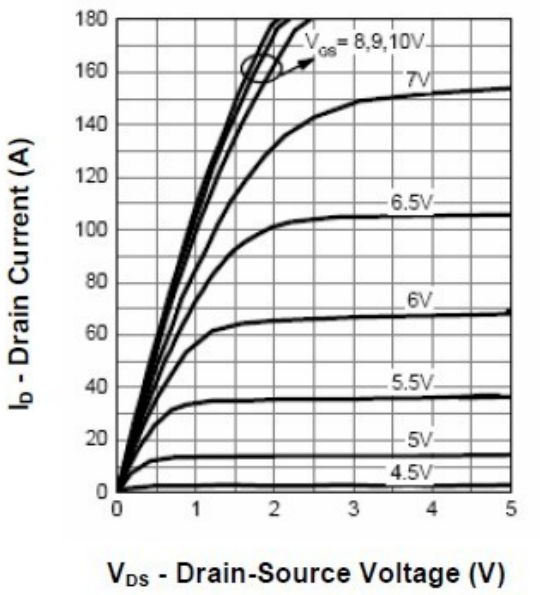


Thermal Transient Impedance

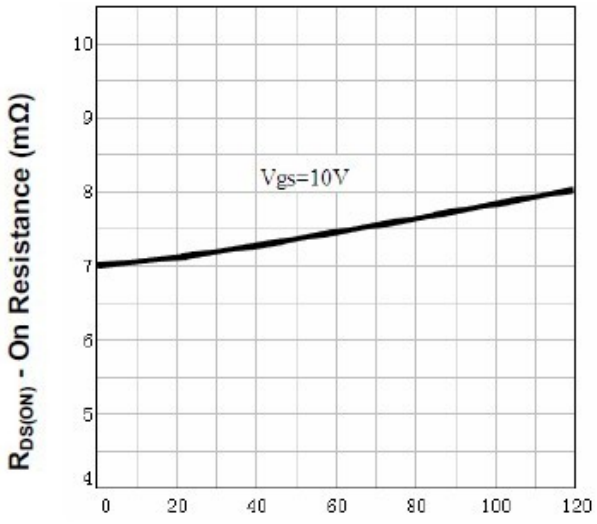


Typical Characteristics

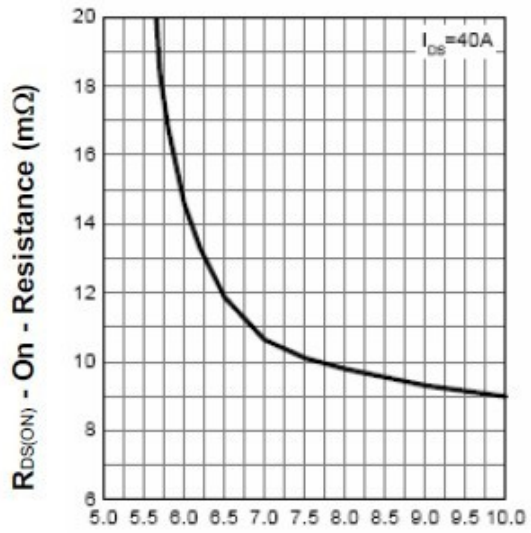
Output Characteristics



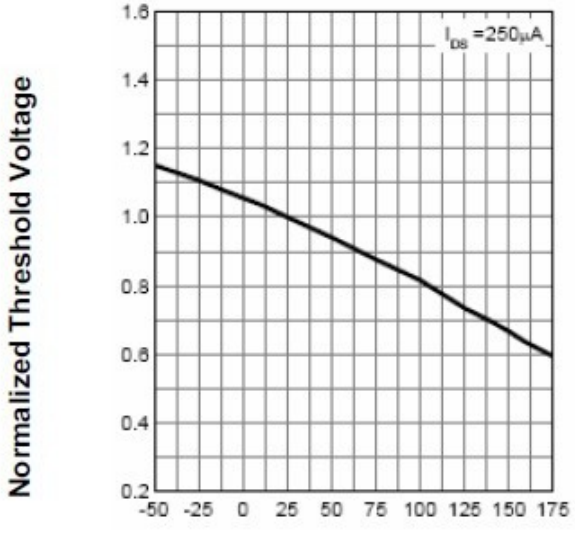
Drain-Source On Resistance



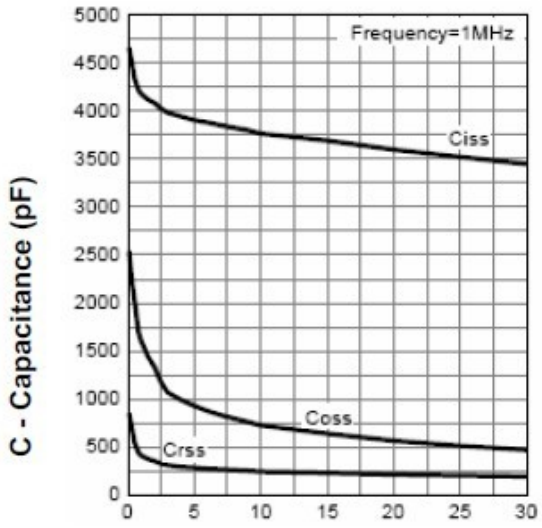
Drain-Source On Resistance



Gate Threshold Voltage

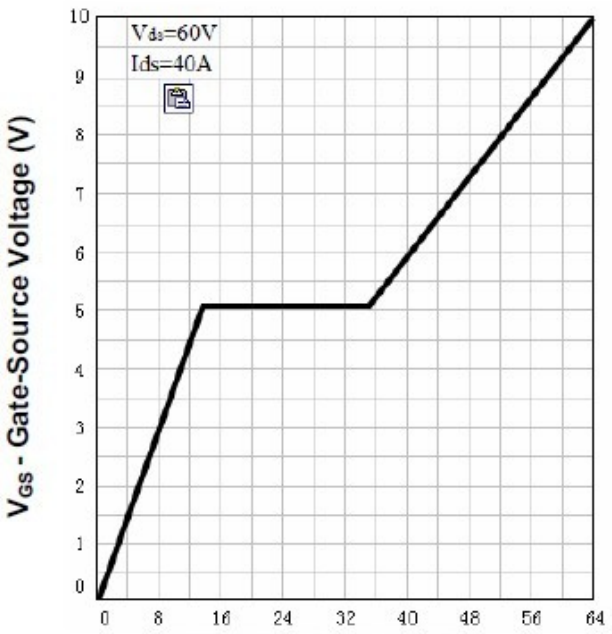


Capacitance



V_{DS} - Drain-Source Voltage (V)

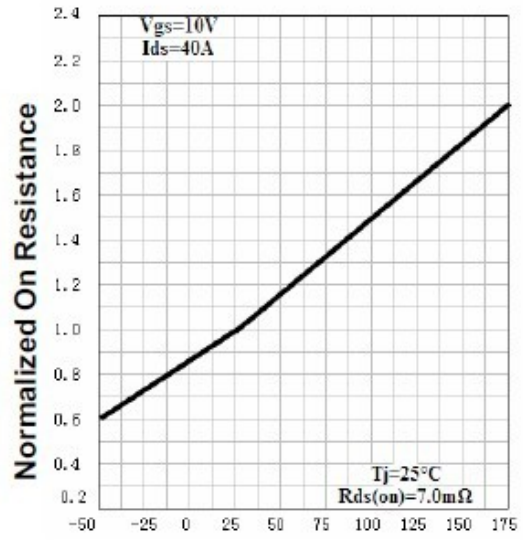
Gate Charge



Q_G - Gate Charge (nC)

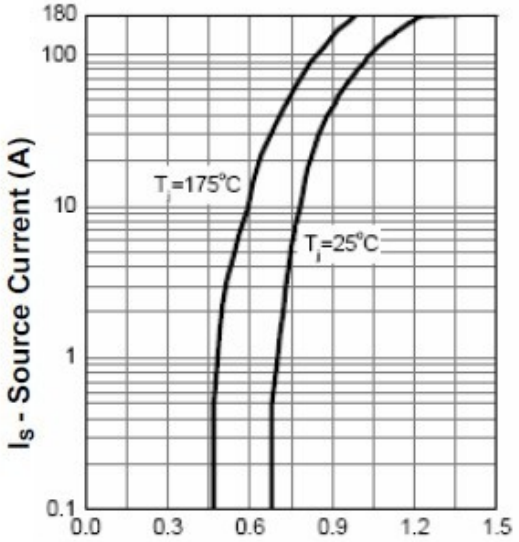
Typical Characteristics

Drain-Source On Resistance



T_j - Junction Temperature (°C)

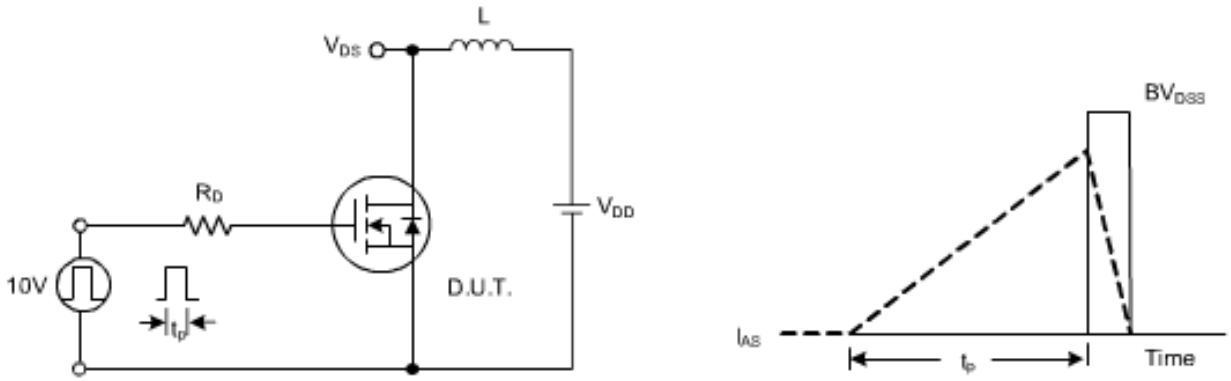
Source-Drain Diode Forward



V_{SD} - Source-Drain Voltage (V)

Test Circuits

Avalanche test circuits and waveforms



Gate charge test circuits and waveforms